



Product Change Notification

Change Notification #: 115107 - 00

Change Title: Intel® Ethernet Converged Network Adapter X520 - DA1, E10G41BTDAPG1P5, Spring Fountain, MM#927066,
Intel® Ethernet Converged Network Adapter X520 - DA2, E10G42BTDAPG1P5, Spring Fountain, MM#927067,
Intel® Ethernet Server Adapter I210-T1, I210T1, Beaver Lake, MM#921433,
Intel® Ethernet Server Adapter I210-T1, I210T1BLK, Beaver Lake, MM#921434,
Intel® Ethernet Server Adapter I210-T1, I210T1G1P20, Beaver Lake, MM#921435,
Intel Ethernet Converged Network Adapter X550-T1, X550T1, Sage Pond, MM#940116,
Intel Ethernet Converged Network Adapter X550-T1, X550T1BLK, Sage Pond, MM#940215,
Intel Ethernet Converged Network Adapter X550-T1, X550T1G1P5, Sage Pond, MM#940262,
Intel Ethernet Converged Network Adapter X550-T2, X550T2, Sage Pond, MM#940128,
Intel Ethernet Converged Network Adapter X550-T2, X550T2BLK, Sage Pond, MM#940136,
Intel Ethernet Converged Network Adapter X550-T2, X550T2G1P5, Sage Pond, MM#940263
PCN115107-00, Label, Transport Media,
OUI, Outerbox and Clamshell update

Date of Publication: March 13, 2017

Key Characteristics of the Change:

Label, Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 28, 2017
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Description of Change to the Customer:

1. These Intel products will undergo the following changes:

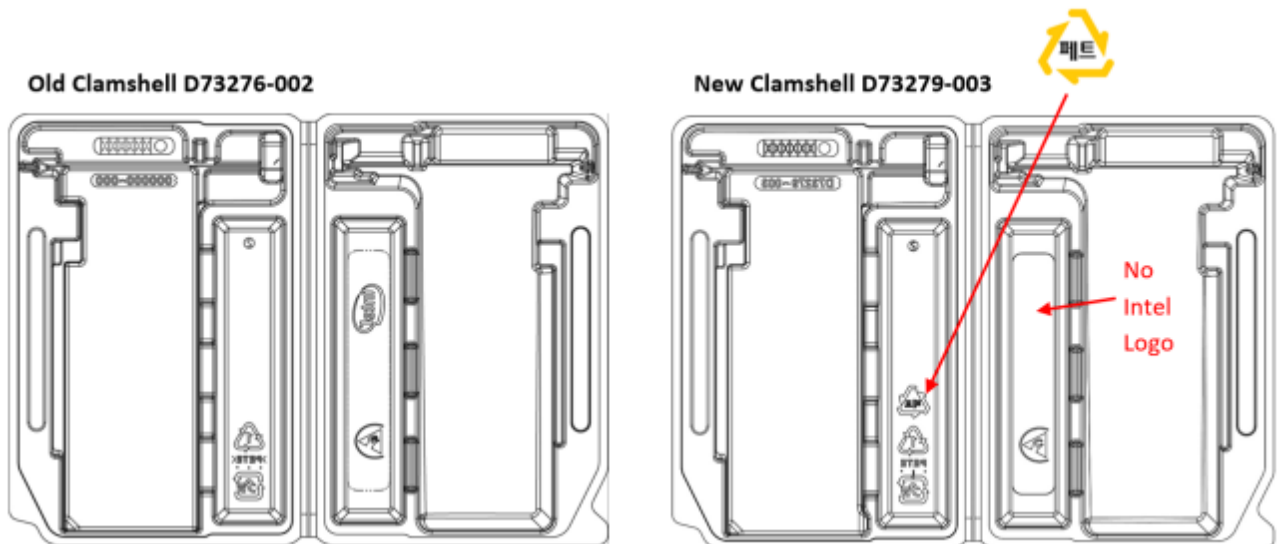
I210T1	Beaver Lake	00-1B-21
I210T1BLK	Beaver Lake	00-1B-21
I210T1G1P20	Beaver Lake	00-1B-21
E10G41BTDAPG1P5	Spring Fountain	B4-96-91
E10G42BTDAPG1P5	Spring Fountain	B4-96-91

The OUI Block A0-36-9F has hit the low water mark, the new OUI Block used will be as shown above. As a result of this change, the PBA (printed board assembly) and TA (top assembly) numbers will roll as noted in the affected products table within this PCN notice. If the PBA/TA numbers are printed on any product or box labels, those will show the PBA/TA dash roll as well.

2. These Intel products will undergo the following change:

Sage Pond	X550T2G1P5
Sage Pond	X550T2
Sage Pond	X550T2BLK
Sage Pond	X550T1G1P5
Sage Pond	X550T1
Sage Pond	X550T1BLK
Spring Fountain	E10G41BTDAPG1P5
Spring Fountain	E10G42BTDAPG1P5

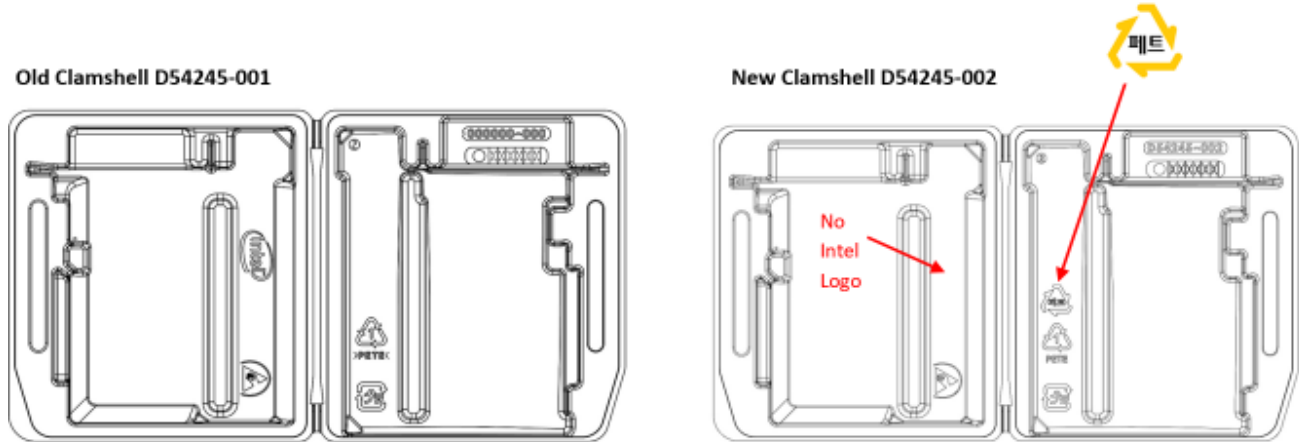
South Korea instituted revised Packaging Recycling legislation adding the below mark to the clamshell. The Intel logo will be removed from the clamshell. The part number on the clamshell will be updated from D73276-002 to D73279-003.



3. These Intel products will undergo the following change:

Beaver Lake	I210T1
Beaver Lake	I210T1BLK
Beaver Lake	I210T1G1P20

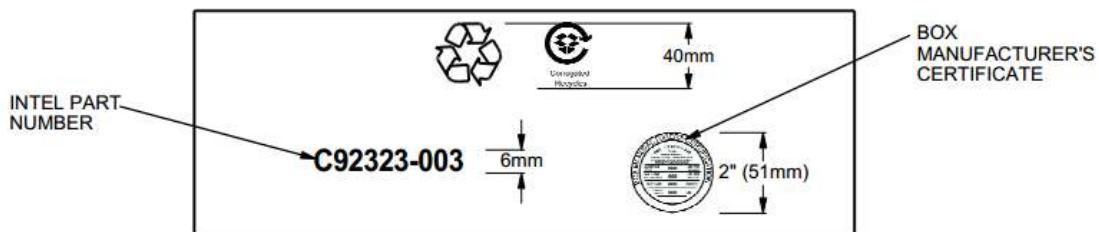
South Korea instituted revised Packaging Recycling legislation adding the below mark to the clamshell. The Intel logo will be removed from the clamshell. The part number on the clamshell will be updated from D54245-001 to D54245-002



4. These Intel products will under undergo this additional change:

Sage Pond	X550T2G1P5
Sage Pond	X550T2
Sage Pond	X550T2BLK
Sage Pond	X550T1G1P5
Sage Pond	X550T1
Sage Pond	X550T1BLK
Spring Fountain	E10G41BTDAPG1P5
Spring Fountain	E10G42BTDAPG1P5

The outer box is updating to a thicker corrugated lining to help reinforce box strength for shipping. The part number on the box will go from C92323-002 to C92323-003 as shown:



Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Customers can expect to receive mixed inventory.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
I210T1	921433	G86562-004	G69016-003	G86562-005	G69016-004
I210T1BLK	921434	G86594-003	G69016-003	G86594-004	G69016-004
I210T1G1P20	921435	G79024-005	G59947-009	G79024-006	G59947-010
E10G41BTDAPG1P5	927066	G83817-003	G83818-003	G83817-004	G83818-004
E10G42BTDAPG1P5	927067	G83820-002	G83821-002	G83820-003	G83821-003
X550T1	940116	H92760-002	H92506-004	H92760-003	H92506-005
X550T1BLK	940125	H99159-002	H92506-004	H99159-003	H92506-005
X550T2	940128	H92776-002	H86377-005	H92776-003	H86377-006
X550T2BLK	940136	H99164-002	H86377-005	H99164-003	H86377-006
X550T1G1P5	940262	H92735-002	H89173-005	H92735-003	H89173-006
X550T2G1P5	940263	H92727-002	H49289-010	H92727-003	H49289-011

PCN Revision History:**Date of Revision:**

March 13, 2017

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

115107 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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